

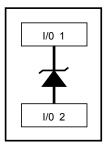
ESDAXLC6-1MY2

Datasheet

Extra low capacitance single line transient voltage surge suppressor (TVS)



SOD882 (µQFN-2L)



GND

Product status link	
ESDAXLC6-1MY2	

Features

- Extra low capacitance 0.6 pF max on a wide frequency spectrum (200 MHz -3000 MHz)
- Unidirectional device
- Low clamping factor V_{CL} / V_{BR}
- Fast response time
- Very thin package: 0.55 mm max
- Low leakage current
- High ESD protection level
- High integration
- Suitable for high density boards
- Complies with the following standards
 - IEC 61000-4-2 level 4
 - MIL STD 883G-Method 3015-7: class 3B

Applications

Where transient overvoltage protection in ESD sensitive equipment is required, such as:

- Computers
- Printers
- Communication systems
- Cellular phone handsets and accessories
- Video equipment Portable equipment

Description

The ESDAXLC6-1MY2 is a single line Transil diode designed specifically for the protection of integrated circuits in portable equipment and miniaturized electronics devices subject to ESD transient over voltages.

Packaged in SOD882 (µQFN-2L), it minimizes PCB consumption.

1 Characteristics

Symbol		Value	Unit		
V _{PP}	Peak pulse voltage	IEC 61000-4-2, level 4 : contact discharge	8	kV	
P _{PP}	Peak pulse power	Peak pulse power $8/20\mu s^{(1)}$, T _j initial = T _{amb}			
I _{PP}	Peak pulse current typical	2.8	А		
T _{stg}	Storage temperature range	-55 to +150	°C		
T _{op}	Operating temperature ran	-40 to +125	C		

Table 1. Absolute maximum ratings (T_{amb} = 25 °C)

1. For a surge greater than the maximum values, the diode will fail in short-circuit.

Figure 1. Electrical characteristics (definitions)

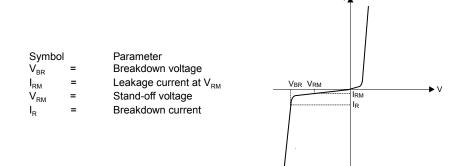
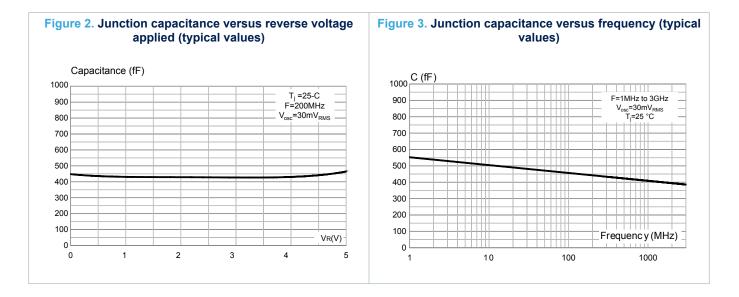


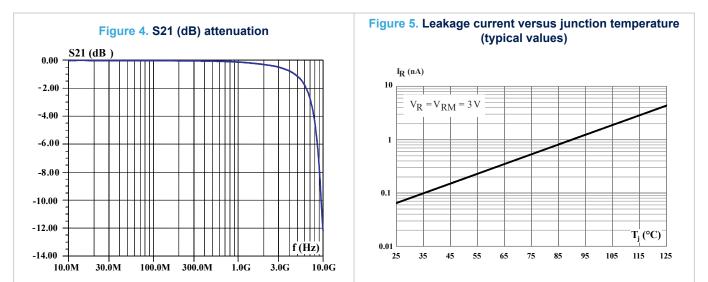
Table 2. Electrical characteristics (values) (T_{amb} = 25° C)

Symbol	Test conditions	Min.	Тур.	Max.	Unit
V _{BR}	I _R = 1 mA	6	-		V
I _{RM}	V _{RM} = 3 V		-	100	nA
C _{LINE}	V_{R} = 0 V, F = (200 MHz - 3000 MHz), V_{OSC} = 30 mV		-	0.6	pF

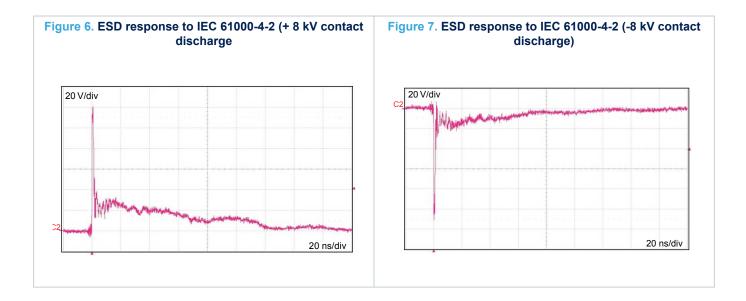


1.1 Characteristics (curves)









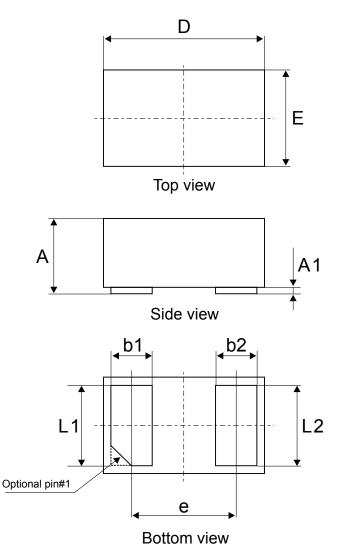
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SOD882 package information

- Epoxy meets UL 94, V0
- Lead-free package





	Dimensions						
Ref.	Millimeters			inches (dimension in inches are given for reference only)			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.45	0.50	0.55	0.018	0.020	0.022	
A1	0.00		0.05	0.000	0.000	0.002	
b1	0.20	0.25	0.30	0.008	0.010	0.012	
b2	0.20	0.25	0.30	0.008	0.010	0.012	
D	0.95	1.00	1.05	0.037	0.039	0.041	
E	0.55	0.60	0.65	0.022	0.024	0.026	
е		0.65			0.026		
L1	0.45	0.50	0.55	0.018	0.020	0.022	
L2	0.45	0.50	0.55	0.018	0.020	0.022	

Table 3. SOD882 package mechanical data

Figure 9. SOD882 recommended footprint

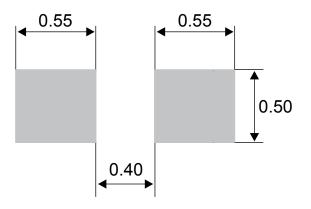
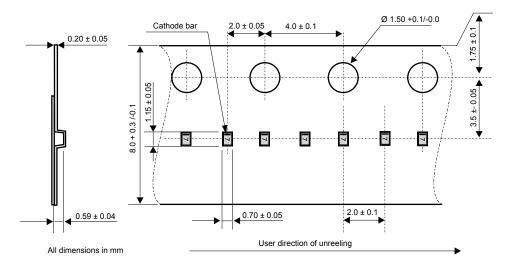


Figure 10. Marking



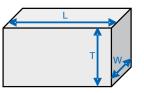


3 Recommendation on PCB assembly

3.1 Stencil opening design

- 1. General recommendation on stencil opening design
 - a. Stencil opening dimensions: L (Length), W (Width), T (Thickness).

Figure 12. Stencil opening recommendation



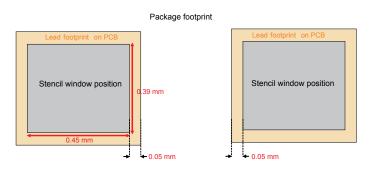
- b. General design rule
 - \circ Stencil thickness (T) = 75 ~ 125 μ m

$$\sim \frac{W}{T} \ge 1.5$$

$$\circ \qquad \frac{L \times W}{2T(L+W)} \ge 0.66$$

- 1. Reference design
 - a. Stencil opening thickness: 100 µm
 - b. Stencil opening for leads: Opening to footprint ratio is 90%

Figure 13. Recommended stencil window position in mm



3.2 Solder paste

- 1. Halide-free flux qualification ROL0 according to ANSI/J-STD-004.
- 2. "No clean" solder paste is recommended.
- 3. Offers a high tack force to resist component movement during high speed.
- 4. Use solder paste with fine particles: powder particle size 20-45 μ m.

3.3 Placement

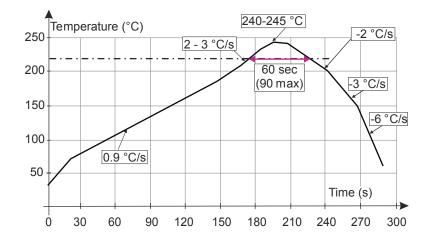
- 1. Manual positioning is not recommended.
- 2. It is recommended to use the lead recognition capabilities of the placement system, not the outline centering
- 3. Standard tolerance of ±0.05 mm is recommended.
- 4. 3.5 N placement force is recommended. Too much placement force can lead to squeezed out solder paste and cause solder joints to short. Too low placement force can lead to insufficient contact between package and solder paste that could cause open solder joints or badly centered packages.
- 5. To improve the package placement accuracy, a bottom side optical control should be performed with a high resolution tool.
- 6. For assembly, a perfect supporting of the PCB (all the more on flexible PCB) is recommended during solder paste printing, pick and place and reflow soldering by using optimized tools.

3.4 PCB design preference

- 1. To control the solder paste amount, the closed via is recommended instead of open vias.
- 2. The position of tracks and open vias in the solder area should be well balanced. A symmetrical layout is recommended, to avoid any tilt phenomena caused by asymmetrical solder paste due to solder flow away.

3.5 Reflow profile

Figure 14. ST ECOPACK[®] recommended soldering reflow profile for PCB mounting



Note:

Minimize air convection currents in the reflow oven to avoid component movement.



4 Ordering information

Figure 15. Ordering information scheme

	ESDAX LC 6 - 1MY2
ESDA array	
Low capacitance	
Breakdown voltage	
6 = 6 V minimum Package	
1 = 1 line MX = SOD882 (uOEN-21.) max beight:0.55 mm	

MY = SOD882 (µQFN-2L), max.height:0.55 mm

2 = 2 pads

Table 4. Ordering information

Order code	Marking	g Package Weight Base qty.		Base qty.	Delivery mode	
ESDAXLC6-1MY2	7	SOD882 (µQFN-2L)	0.942 mg	12000	Tape and reel	

Revision history

Date	Revision	Changes
18-Jan-2010	1	Initial release.
23-Sep-2011	2	Updated package name.
31-Mar-2014	3	Updated operating junction temperature range in Table 2. Updated Figure 3, Figure 4, and Figure 6. Updated graphic and dimension names in Table 3, Updated Figure 15.
19-Sep-2019	4	Updated Section 2.1 SOD882 package information.

Table 5. Document revision history



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